

# 2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

PowerDI<sup>®</sup>123

DFLS220L

## **Features**

- Guard Ring Die Construction for Transient Protection ٠
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead Free Finish, RoHS Compliant (Note 5)
- "Green" Molding Compound (No Br, Sb)

# **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Plastic Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed Over Copper leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

# Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	V
Average Forward Current	I <sub>F(AV)</sub>	2.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	40	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	1.67	W
Power Dissipation (Note 2)	PD	556	mW
Thermal Resistance Junction to Ambient (Note 1)	R <sub>0</sub> JA	60	°C/W
Thermal Resistance Junction to Ambient (Note 2)	$R_{ heta JA}$	180	°C/W
Thermal Resistance Junction to Soldering (Note 3)	R <sub>0JS</sub>	10	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	۵°

### Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	V <sub>(BR)R</sub>	20	_	_	V	I <sub>R</sub> = 1.0mA
Forward Voltage	V <sub>F</sub>		0.32 0.375	0.36 0.42	V	I <sub>F</sub> = 1.0A I <sub>F</sub> = 2.0A
Leakage Current (Note 4)	I <sub>R</sub>		0.26	 1.0	mA	V <sub>R</sub> = 5V, T <sub>A</sub> = 25°C V <sub>R</sub> = 20V, T <sub>A</sub> = 25°C
Total Capacitance	CT		75	_	pF	V <sub>R</sub> = 10V, f = 1.0MHz

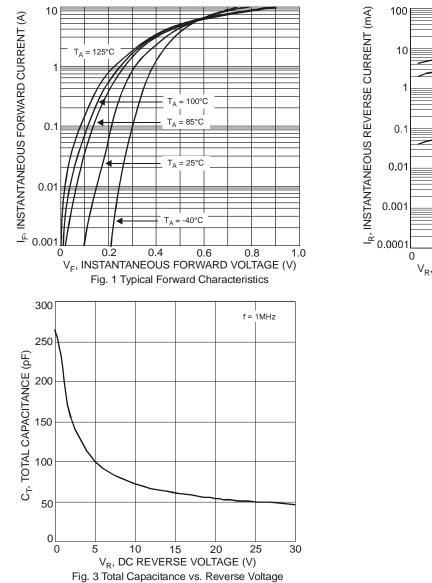
1. Part mounted on 50.8mm X 50.8mm GETEK board with 25.4mm X 25.4mm copper pad, 25% anode, 75% cathode. T<sub>A</sub> = 25°C. Notes:

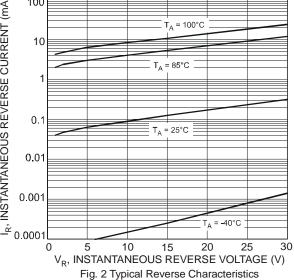
2. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads. T<sub>A</sub> = 25°C.

3. Theoretical  $R_{0,S}$  calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

Short duration pulse test used to minimize self-heating effect.
EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.







# Ordering Information (Note 6)

Part Number	Case	Packaging
DFLS220L-7	PowerDI <sup>®</sup> 123	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## Marking Information



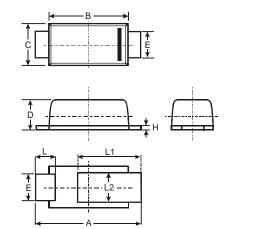
F02A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code K	ley											
Year	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	R	S	Т	U	V	W	Х	Y	Z	A	В	С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
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Code	1	2	3	4	5	6	7	8	9	0	N	D

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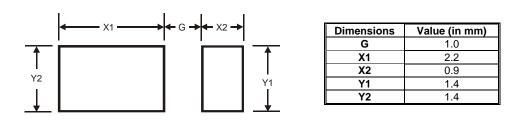


## **Package Outline Dimensions**



PowerDI <sup>®</sup> 123							
Dim	Min	Max	Тур				
Α	3.50	3.90	3.70				
В	2.60	3.00	2.80				
С	1.63	1.93	1.78				
D	0.93	1.00	0.98				
Ε	0.85	1.25	1.00				
Н	0.15	0.25	0.20				
L	0.55	0.75	0.65				
L1	1.80	2.20	2.00				
L2	0.95	1.25	1.10				
All Dimensions in mm							

# **Suggested Pad Layout**



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